

### 32-01/G4C-AQSB

#### **Benefits**

- . High Flux Output.
- . Low Profile.
- . Low Thermal Resistance.
- . Low Power Consumption.
- .The product itself will remain within RoHS compliant version.
- . ESD-withstand voltage: up to 4KV.



### **Descriptions**

This revolutionary package design allows the light designer to reduce the number of LEDs required and provide a more uniform and unique illuminated appearance than with other LED solutions. This is possible through the efficient optical package design and high-current capabilities.

The low profile package can be easily coupled with reflectors or lenses to efficiently distribute light and provide the desired light appearance.

### **Applications**

- . Automotive Exterior Lighting
- . Electronic Signs and Signals
- . Channel Letter
- . Special Lighting application

#### **Device Selection Guide**

2.222	C		
PART NO.	Material	<b>Emitted Color</b>	Lens Color
32-01/G4C-AQSB	InGaN	Brilliant Green	Water Clear

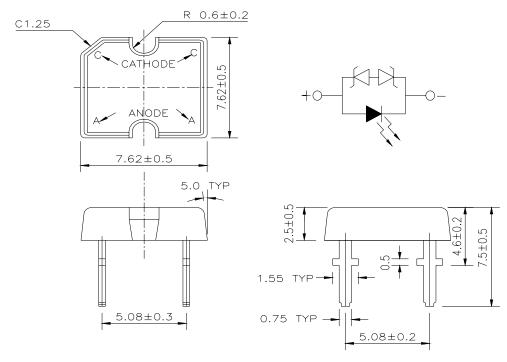
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Device number: DLE-302-029 Established date: 04-30-2007 Established by: Jim Lin



## 32-01/G4C-AQSB

### **Package Dimensions**



**Notes:** 1.All dimensions are in millimeters

- 2.An epoxy meniscus may extend about 1.5mm(0.059") down the leads
- 3. Tolerances unless dimensions ±0.25mm

### **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_{\mathrm{F}}$	30	mA
Peak Forward Current(Duty 1/10 @ 1KHZ)	$I_{FP}$	100	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ m stg}$	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Soldering Temperature(T=5 sec)	$T_{sol}$	260 ± 5	$^{\circ}\mathbb{C}$
Power Dissipation	P <sub>d</sub>	120	mW
Zener Reverse Current	Iz	100	mA
Electrostatic Discharge	ESD	4K	V
LED Junction Temperature	$T_{j}$	110	$^{\circ}\!\mathbb{C}$

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### **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Condition	Unit
Total Flux	Фv	3600	4500	7150	I <sub>F</sub> =30mA	mlm
Viewing Angle	2 0 1/2		130		I <sub>F</sub> =30mA	deg
Peak Wavelength	λр		518		I <sub>F</sub> =30mA	Nm
<b>Dominant Wavelength</b>	λd	520	525	532	I <sub>F</sub> =30mA	Nm
Forward Voltage	VF	3.0	3.5	4.0	I <sub>F</sub> =30mA	V
Reverse Current	IR			10	V <sub>R</sub> =5V	uA
Zener Reverse Voltage	Vz	5.2			Iz=5mA	V

### Rank

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(1)

(3)

	(1) VF(V)		(2) λd		$(3) \Phi v(mlm)$			
Bin.	Min.	Max.	Bin.	Min.	Max.	Bin.	Min.	Max.
1	3.00	3.20	3	520	524	Q	3600	4500
2	3.20	3.40	4	524	528	R	4500	5650
3	3.40	3.60	5	528	532	S	5650	7150
4	3.60	3.80						
5	3.80	4.00						

(2)

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<sup>\*</sup>Measurement Uncertainty of Forward Voltage :  $\pm 0.1V$ 

<sup>\*</sup>Measurement Uncertainty of Luminous Intensity: ±15%

<sup>\*</sup>Measurement Uncertainty of Dominant Wavelength ±1.0nm



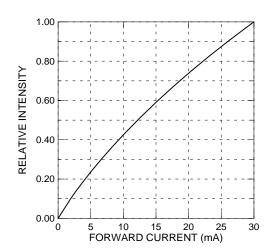
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### **Typical Electro-Optical Characteristics Curves**

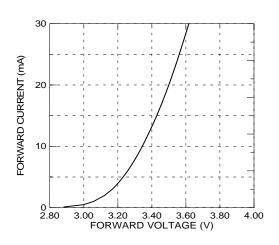
### Relative Intensity vs. Wavelength

## 1.00 LINE NO.50 0.50 450 475 500 525 550 575 600 625 650 WAVELENGTH (nm)

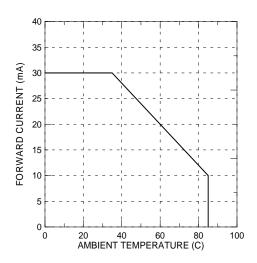
### **Relative Intensity vs. Forward Current**



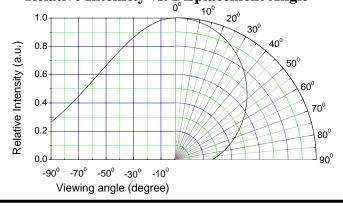
### Forward Current vs. Forward Voltage



### Forward Current vs. Ambient Temp.



### Relative Intensity vs. Displacement Angle



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### 32-01/G4C-AQSB

### **Packing Quantity Specification**

- (1) 60 pcs/1 tube, 30 tubes/1 small inside box, 12 small inside boxes/1 outside box
- (2) 60 pcs/1 tube, 105 tubes/1 big inside box, 4 big inside boxes/1 outside box

### **Label Form Specification**

(1) Tube Label Form

PART NO: 32-01/G4C-AOSB OTY: 60 **EVERLIGHT** LOT NO: CAT:

(2)Box Label Form

EVERLIGHT	
CPN:	
P/N:	
	<sub>  RoHS</sub>
32-01/G4C-AQSB	
QTY:	CAT:
	HUE:
LOT NO:	REF:
8 81 1 <b>6 18 18 86 18 86 18 18 18 18 18 18</b> 18 18 18 18 18 18 18 18 18 18 18 18 18	
MADE IN TAIWAN	N

PART NO: Everlgiht's Production Number

QTY: Packing Quantity LOT NO: Lot Number

CAT: Ranks of Forward Voltage, Dominant Wavelength and Total Flux

CPN: Customer's Production Number

P/N: Production Number

**HUE: Reference REF:** Reference

MADE IN TAIWAN: Production Place

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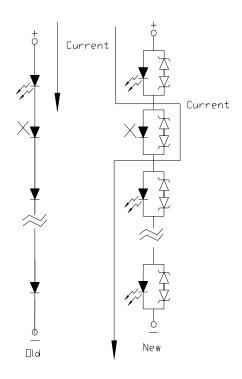
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#### **Notes**

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
- 4. Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- 5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light.



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### 6. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	400°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp.	265 Max.	
Distance	3mm Min.(From solder joint to case)	Bath time.	5 sec Max.	
	to case)	Distance	3mm Min.	

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